

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6311813

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MAN CHUN TSENG	10/17/2017
ABHISHEK KUMAR SRIVASTAVA	10/17/2017
CUILING MENG	10/17/2017
VLADIMIR GRIGORIEVICH CHIGRINOV	10/17/2017
HOI SING KWOK	10/17/2017
YU SHI	10/17/2017
YEUK LUNG JACOB HO	10/17/2017
CHENXIANG ZHAO	10/17/2017
RECEIVING PARTY DATA	
Name:	THE HONG KONG UNIVERSITY OF SCIENCE AND TECHNOLOGY
Street Address:	CLEAR WATER BAY
Internal Address:	KOWLOON
City:	HONG KONG
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17028464
CORRESPONDENCE DATA	
Fax Number:	(312)616-5700
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	312-616-5600
Email:	Chgpatent@leydig.com
Correspondent Name:	LEYDIG VOIT & MAYER, LTD
Address Line 1:	TWO PRUDENTIAL PLAZA, SUITE 4900
Address Line 2:	180 NORTH STETSON AVENUE
Address Line 4:	CHICAGO, ILLINOIS 60601-6745
ATTORNEY DOCKET NUMBER:	750667
NAME OF SUBMITTER:	LEONARD Z. HUA
SIGNATURE:	/Leonard Z. Hua/

PATENT

DATE SIGNED:	09/22/2020
Total Attachments: 11 source=17028464#page1.tif source=17028464#page2.tif source=17028464#page3.tif source=17028464#page4.tif source=17028464#page5.tif source=17028464#page6.tif source=17028464#page7.tif source=17028464#page8.tif source=17028464#page9.tif source=17028464#page10.tif source=17028464#page11.tif	

PATENT

Attorney Docket No. 730442

Client Reference No. TTC.PA.0894&959&0991

Leydig, Volt & Mayer, Ltd.
Two Prudential Plaza
Suite 4900
Chicago, Illinois 60601-6731

ASSIGNMENT

WHEREAS, WE,

- (1) Man Chun TSENG of Flat 3714, Ching Ping House, Ching Ho Estate, Sheung Shui, New Territories, Hong Kong, CHINA;
- (2) Abhishek Kumar SRIVASTAVA of 268/181, Achar Wali Gali, Aishbagh Lucknow, INDIA 226004;
- (3) Coiling MENG of Flat H4, 27/F, Yuanzhou Garden, Yuanzhou Town, Huizhou City, Guangdong Province, CHINA;
- (4) Vladimir Grigorievich CHIGRINOV of No. 80A, Nam Shan, DD220, LOT No. 1015, Sai Kung, New Territories,, Hong Kong, CHINA;
- (5) Hoi Sing KWOK of Flat H, Tower 1, 56/F, Metro Town, 6 King Ling Road, Tiu Keng Leng, Tseung Kwan O, New Territories, Hong Kong, CHINA;
- (6) Yue SHI of Apartment 16-2-6, Donggangli, Haigang District, Qinhuangdao City, Hebei Province, CHINA;
- (7) Yeuk Lung Jacob HO of 29G, Block 1, La Cite Noble, 1 Ngan O Road, Tseung Kwan O, New Territories, Hong Kong, CHINA; and
- (8) Chenxiang ZHAO of G/F, 112B, Tai Po Tsai Village, Clear Water Bay, Kowloon, Hong Kong, CHINA;

hereinafter referred to as Assignor(s), have invented a certain invention entitled:

COMPOSITE PHOTOALIGNMENT LAYER

for which invention an application (provisional or non-provisional) for a U.S. patent was filed on October 17, 2017, under U.S. Application No. 15/785,723, and

WHEREAS, The Hong Kong University of Science and Technology, of Clear Water Bay, Kowloon, Hong Kong, CHINA, hereinafter referred to as Assignee, is desirous of acquiring the entire right, title, and interest in, to, and under the invention described in the patent application, including the entire priority right derived from the application.

In re Appln. of: Tseng et al.
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NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged.

Assignor(s) assigns and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the entire right, title, and interest in, to, and under the invention and any and all improvements thereof, the referenced patent application, other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, national and regional phase applications, petty patent applications, and utility model applications) that may be filed in the U.S. and/or any country foreign to the U.S. on the invention, the patents that may issue thereon, and the patents as may be modified as the result of applicable procedures (e.g., supplemental examinations, ex parte reexaminations, inter partes reexaminations, inter partes reviews, post-grant reviews, and oppositions),

Assignor(s) conveys to the Assignee the right to make applications in Assignee's own behalf for protection of the invention in the U.S. and countries foreign to the U.S. and to claim priority to the referenced patent application and other such applications that may be filed in the U.S. or any country foreign to the U.S. on the invention under the Patent Cooperation Treaty, the Paris Convention, and any other international arrangements,

Assignor(s) will not execute any writing or do any act conflicting with the terms of this assignment, and Assignor(s) covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment,

Assignor(s) will at any time request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to pursue the patent applications identified herein, including, but not limited to, rendering all necessary assistance in making applications for and obtaining patents that may issue thereon in the U.S. and any countries foreign to the U.S. on the invention, and in enforcing any rights accruing as a result of such applications or patents, by, for example, executing statements and other affidavits,

Assignor(s) and Assignee agree the terms of this assignment shall bind, and inure to the benefit of, the legal representatives, successors, and assigns of all parties hereto,

Assignor(s) authorizes Assignee to insert in this Assignment the number and filing date of the application if the number and filing date of the application are not recited herein at the time of execution of this assignment by any or all of the parties hereto,

Assignor(s) and Assignee agree that U.S. law governs this assignment, and

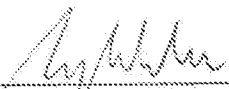
Assignee acknowledges and accepts this assignment.

IN WITNESS WHEREOF, we have hereunder set our hands on the dates shown below.

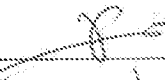
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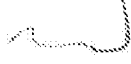
Date 17 OCT 2017


Assignor Man Chun TSENG

Date 17 OCT 2017

Witness 

Date 17 OCT 2017

Witness 

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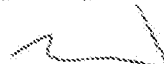
Date 17 OCT 2017

Date 17 OCT 2017

Date 17 OCT 2017


Assignor: **Abhishek Kumar SRIVASTAVA**

Witness 

Witness 

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Date 17 OCT 2017

Date 17 OCT 2017

Date 17 OCT 2017

Cuiling MENG
Assignor: Cuiling MENG

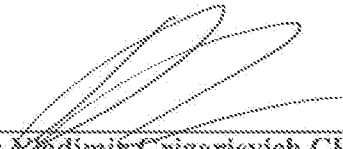
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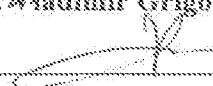
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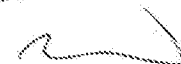
Date 17 OCT 2017

Assignor:  Vladimir Grigorievich CHIGRINOV

Date 17 OCT 2017

Witness  _____

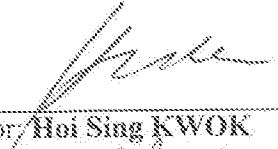
Date 17 OCT 2017

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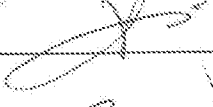
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Attorney Docket No 730442

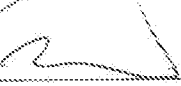
Date 17 OCT 2017


Assignor Hoi Sing KWOK

Date 17 OCT 2017


Witness

Date 17 OCT 2017


Witness

In re Appln. of: Tseng et al.
Attorney Docket No 730442

Date Oct. 17, 2017

Date 17 OCT 2017

Date 17 OCT 2017

Yue SHI
Assignor: Yue SHI

[Signature]
Witness

[Signature]
Witness

In re Appln. of: Tseng et al.
Attorney Docket No 730442

Date 17 OCT 2017

Date 17 OCT 2017

Date 17 OCT 2017

Tseng
Assignor: Yeuk Lung Jacob HO

Witness [Signature]

Witness [Signature]

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Attorney Docket No 730442

Date 17 OCT 2017

Date 17 OCT 2017

Date 17 OCT 2017

ZHAO Chenxiang
Assignor: Chenxiang ZHAO

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Witness

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Witness

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